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Claims:

1. A temperature controlled arrangement for housing an optical component, comprising:

a package having an enclosure through which a plurality of electrical connections extend;

at least one optical component located in the enclosure and electrically connected to at least one of the electrical connections;

a first thermoelectric cooler located in the enclosure and in thermal conduction with the optical component;

a temperature sensor located in the enclosure and electrically connected to at least one of the electrical connections; and

a second thermoelectric cooler located external to the enclosure and in thermal conduction with the enclosure.

- 2. The arrangement of claim 1 wherein at least one of the plurality of electrical connections electrically connects the first and second thermoelectric coolers.
- 3. The arrangement of claim 2 wherein the first and second thermoelectric coolers are electrically connected in series.
- 4. The arrangement of claim 2 wherein the first and second thermoelectric coolers are electrically connected in parallel.
- 5. The arrangement of claim 1 further comprising a temperature controller operatively controlling the first and second thermoelectric coolers.
- 6. The arrangement of claim 2 further comprising a temperature controller operatively controlling the first and second thermoelectric coolers.
- 7. The arrangement of claim 3 further comprising a temperature controller operatively controlling the first and second thermoelectric coolers.

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8. The arrangement of claim 1 wherein the optical component is a laser diode.

- 9. The arrangement of claim 1 further comprising a thermal conducting element in contact with an outer surface of the enclosure and a first surface of the second thermoelectric cooler.
- 10. The arrangement of claim 1 further comprising a heatsink in contact with a second surface of the second thermoelectric cooler.
- 11. The arrangement of claim 5 wherein said temperature controller is a proportional controller.
- 12. The arrangement of claim 6 wherein said temperature controller is a proportional controller.
- 13. The arrangement of claim 1 wherein said temperature sensor is a thermistor.